

NCE N-Channel Super Trench II Power MOSFET

Description

The NCEP068N10G uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

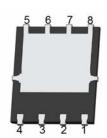
General Features

- V_{DS} =100V,I_D =85A
 - $R_{DS(ON)}$ =6.1m Ω (typical) @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

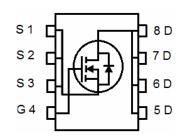
DFN 5X6





Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P068N10G	NCEP068N10G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	85	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	61	А
Pulsed Drain Current	I _{DM}	340	Α
Maximum Power Dissipation	P _D	105	W
Derating factor		0.84	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	320	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	1.2	°C/W



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Electrical Characteristics (T_C=25 [°]C unless otherwise noted)

Off Characteristics Drain-Source Breakdown Voltage Zero Gate Voltage Drain Current Gate-Body Leakage Current	BV _{DSS} I _{DSS} I _{GSS}	V _{GS} =0V I _D =250μA V _{DS} =100V,V _{GS} =0V V _{GS} =±20V,V _{DS} =0V	100	-	<u>-</u> 1	V
Zero Gate Voltage Drain Current Gate-Body Leakage Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	100	-		V
Gate-Body Leakage Current		·	-	-	1	
-	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			ı	μA
			-	-	±100	nA
On Characteristics (Note 3)	1		•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3.3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	6.1	6.8	mΩ
Gate resistance	Rg	F=1.0MHz		1.3		Ω
Forward Transconductance	9 FS	V _{DS} =5V,I _D =40A		60	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	3600	-	PF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V,	-	335	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	19.5	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	16	-	nS
Turn-on Rise Time	t _r	V_{DD} =50 V , I_D =40 A	-	11	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	35	-	nS
Turn-Off Fall Time	t _f		-	9	-	nS
Total Gate Charge	Qg)/ F0)/ 40A	-	60	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=50V,I_{D}=40A,$	-	20		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	15		nC
Drain-Source Diode Characteristics			•	•	•	
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =40A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	85	Α
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C, I_F = 40A$	-	45	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	125	-	nC

Notes:

- ${\it 1. Repetitive Rating: Pulse width limited by maximum junction temperature.}\\$
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V $_{\text{DD}}$ =50 V,V $_{\text{G}}$ =10 V,L=0.5 mH,Rg=25 Ω



Typical Electrical and Thermal Characteristics

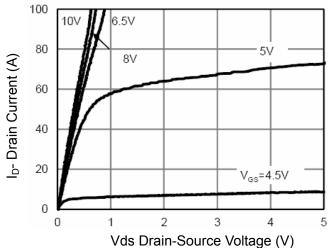


Figure 1 Output Characteristics

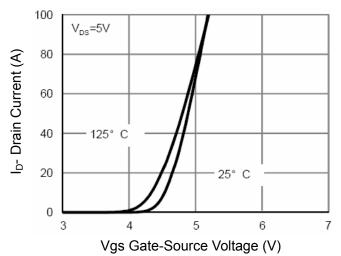


Figure 2 Transfer Characteristics

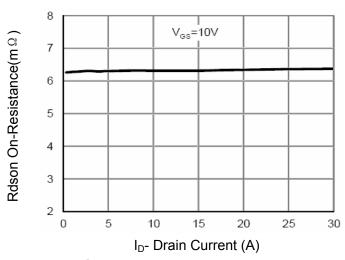


Figure 3 Rdson- Drain Current

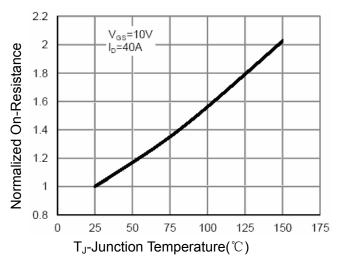


Figure 4 Rdson-Junction Temperature

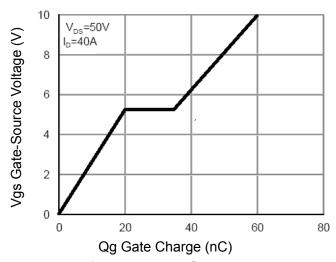


Figure 5 Gate Charge

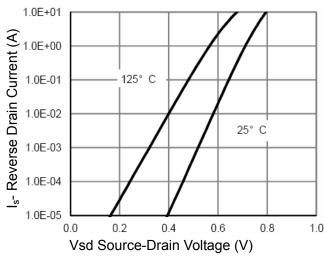
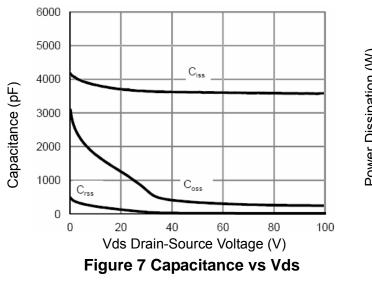


Figure 6 Source- Drain Diode Forward





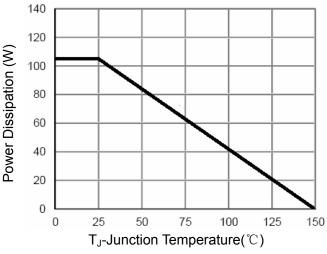
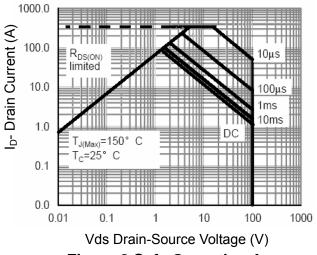


Figure 9 Power De-rating



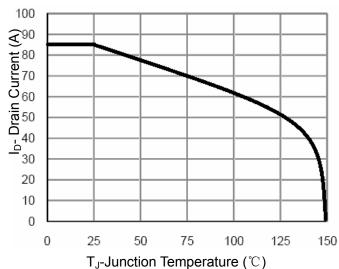
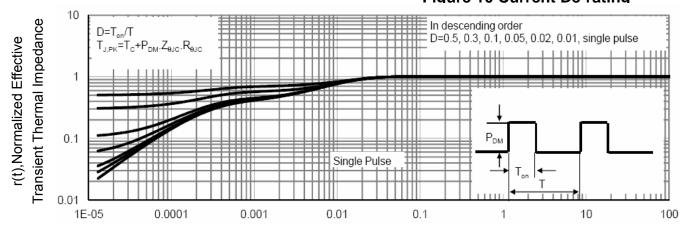


Figure 8 Safe Operation Area

Figure 10 Current De-rating

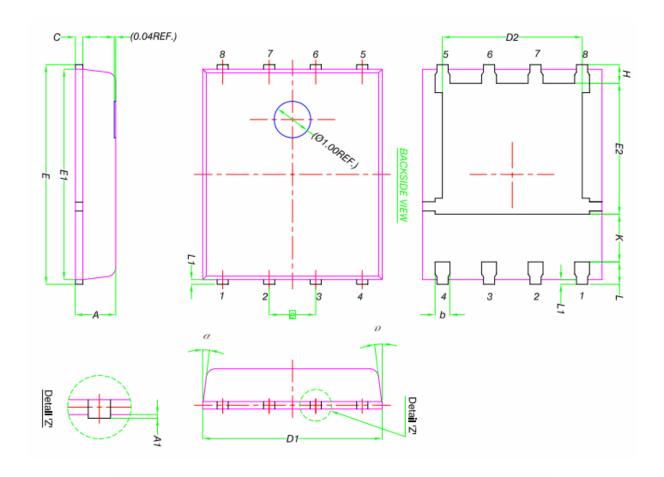


Square Wave Pluse Duration(sec)

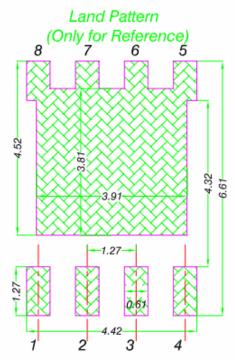
Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



5.44	MILLIMETERS				
DIM.	MIN.	NOM.	MAX.		
Α	0.90	1.00	1.10		
A1	0	-	0.05		
b	0.33	0.41	0.51		
С	0.20	0.25	0.30		
D1	4.80	4.90	5.00		
D2	3.61	3.81	3.96		
Ε	5.90	6.00	6.10		
E1	5.70	5.75	5.80		
E2	3.38	3.58	3.78		
е					
Н	0.41	0.51	0.61		
К	1.10	-	-		
L	L 0.51 L1 0.06		0.71		
L1			0.20		
α	<i>0</i> °	-	12°		



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NCEP068N10G

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